

SiC JFET Division

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Silicon Carbide (SiC) JFET -EliteSiC, Power N-Channel, TO-247-4L, 750 V, 4.8 mohm

Rev. C, January 2025

Description

Qorvo's UJ4N075005K4S is a 750 V, $4.8 m\Omega$ high-performance Gen 4 normally-on SiC JFET transistor. This device exhibits ultra-low on resistance ($R_{DS(on)}$) in a TO-247-4L package, making it an ideal fit to address the challenging thermal constraints of solid-state circuit breakers and relay applications. Additionally, the JFET is a robust device technology capable of the high-energy switching required in circuit protection applications.

Features

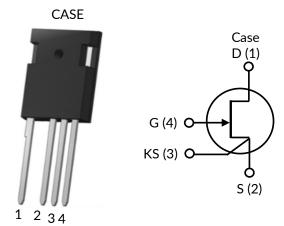
- Single digit on-resistance
- Operating temperature: 175°C (max)
- High pulse current capability
- Excellent device robustness
- Silver-sintered die attach for excellent thermal resistance
- Short circuit rated
- RoHS compliant
- AECQ Qualified

Typical applications

- Solid State / Semiconductor Circuit Breaker
- Solid State / Semiconductor Relay
- Battery Disconnects
- Surge Protection
- Inrush Current Control
- Induction heating



UJ4N075005K4S



| Part Number | Package | Marking | | |
|---------------|-----------|---------------|--|--|
| UJ4N075005K4S | TO-247-4L | UJ4N075005K4S | | |



















Maximum Ratings

| Parameter | Symbol | Test Conditions | Value | Units |
|---|--------------------|--|------------|-------|
| Drain-source voltage | V_{DS} | | 750 | V |
| Cata assuma valtasa | V _{GS} | DC | -30 to +3 | V |
| Gate-source voltage | | AC ¹ | -30 to +30 | V |
| Continuous drain current ² | I _D | T _C < 127°C | 120 | Α |
| Pulsed drain current ³ | I _{DM} | T _C = 25°C | 588 | Α |
| Short circuit withstand time | t _{SC} | $V_{DS} = 400V, T_{J(START)} = 175^{\circ}C$ | 5 | μs |
| Power dissipation | P _{tot} | T _C = 25°C | 714 | W |
| Maximum junction temperature | T _{J,max} | | 175 | °C |
| Operating and storage temperature | T_J , T_{STG} | | -55 to 175 | °C |
| Max. lead temperature for soldering, 1/8" from case for 5 seconds | TL | | 250 | °C |

- 1. +30V AC rating applies for turn-on pulses <200ns applied with external $R_{\rm G}$ > $1\Omega.$
- 2. Limited by bondwires
- 3. Pulse width t_p limited by $T_{J,max}$

Thermal Characteristics

| Darameter | Symbol | Test Conditions | Value | | | - Units |
|--------------------------------------|-----------------|-----------------|-------|------|------|---------|
| Parameter | | | Min | Тур | Max | Units |
| Thermal resistance, junction-to-case | $R_{\theta JC}$ | | | 0.16 | 0.21 | °C/W |













Electrical Characteristics (T_J = +25°C unless otherwise specified)

Typical Performance - Static

| Parameter | Symbol | Test Conditions | Value | | | 11-24- |
|--------------------------------|---------------------|--|-------|------|------|---------|
| | | | Min | Тур | Max | - Units |
| Drain-source breakdown voltage | BV _{DS} | V_{GS} =-20V, I_D =2mA | 750 | | | V |
| | I _{DSS} | V _{DS} =750V, | | 13 | 120 | μΑ |
| Total duain laskage summent | | V _{GS} =-20V, T _J =25°C | | | | |
| Total drain leakage current | | V _{DS} =750V, | | 65 | | |
| | | V _{GS} =-20V, T _J =175°C | | | | |
| Total gate leakage current | 1 | V _{GS} =-20V, T _J =25°C | | 0.1 | 100 | μА |
| | I _{GSS} | V _{GS} =-20V, T _J =175°C | | 0.3 | | μА |
| Drain-source on-resistance | R _{DS(on)} | $V_{GS}=2V$, $I_D=80A$, | | 4.8 | | |
| | | T _J =25°C | | | | |
| | | V _{GS} =0V, I _D =80A, | 5.4 | 5.4 | 6.6 | |
| | | T _J =25°C | | 0.0 | mΩ | |
| | | $V_{GS}=2V$, $I_D=80A$, | 10.4 | | | |
| | | T _J =175°C | | | | |
| | | V_{GS} =0V, I_D =80A, | | 11.9 | | |
| | | T _J =175°C | | | | |
| Gate threshold voltage | V _{G(th)} | V_{DS} =5V, I_D =180mA | -8.3 | -6.0 | -3.7 | V |
| Gate resistance | R_{G} | f=1MHz, open drain | | 0.8 | | Ω |

Typical Performance - Dynamic

| Parameter | Symbol | Test Conditions | Value | | | Unite |
|--------------------------------------|----------------------|---|-----------------------|------|-----|-------|
| | | | Min | Тур | Max | Units |
| Input capacitance | C _{iss} | V _{DS} =400V, V _{GS} =-20V | | 3028 | | |
| Output capacitance | C _{oss} | f=100kHz | | 364 | | pF |
| Reverse transfer capacitance | C _{rss} | | | 360 | | |
| Effective output capacitance, energy | C _{oss(er)} | V _{DS} =0V to 400V, | | 440 | | |
| related | | C _{oss(er)} | V _{GS} =-20V | | 448 | |
| C _{OSS} stored energy | E _{oss} | V _{DS} =400V, V _{GS} =-20V | | 36 | | μЈ |
| Total gate charge | Q_{G} | \/ -400\/ I -80A | | 400 | | |
| Gate-drain charge | Q_{GD} | V_{DS} =400V, I_{D} =80A, V_{GS} = -18V to 0V | | 270 | | nC |
| Gate-source charge | Q_{GS} | $v_{GS} = -18V$ to $0V$ | | 60 | | |













Typical Performance Diagrams

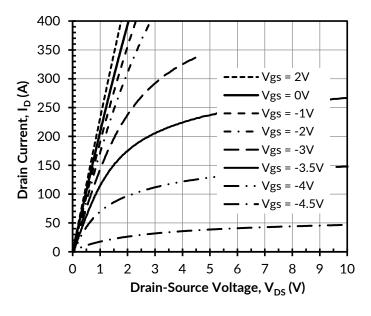


Figure 1. Typical output characteristics at T_J = - 55°C, tp < 250 μ s

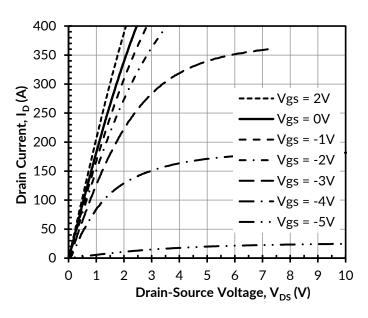


Figure 2. Typical output characteristics at $T_J = 25$ °C, tp < 250μ s

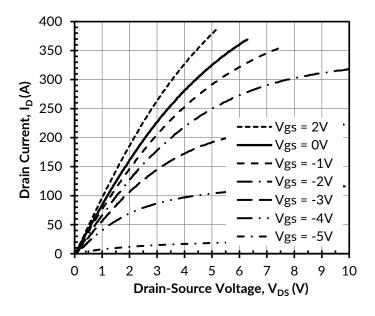


Figure 3. Typical output characteristics at T_J = 175°C, tp < 250 μ s

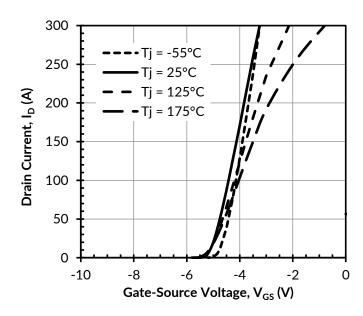


Figure 4. Typical transfer characteristics at $V_{DS} = 5V$





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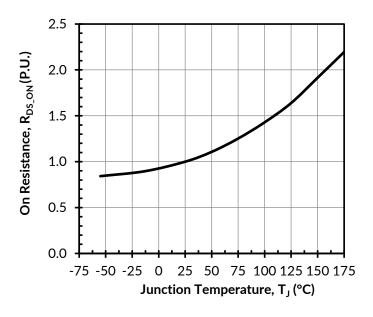


Tj = 175°C

•Tj = 125°C







Tj = 25°C

Tj = -55°C

Tj = -55°C

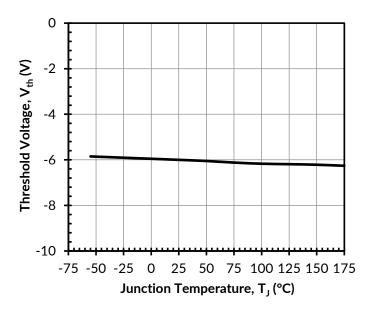
Tj = -55°C

O

Drain Current, I_D (A)

Figure 5. Normalized on-resistance vs. temperature at V_{GS} = 0V and I_D = 80A

Figure 6. Typical drain-source on-resistances at $V_{GS} = 0V$



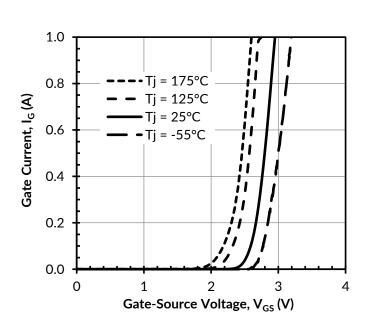


Figure 7. Threshold voltage vs. junction temperature at V_{DS} = 5V and I_{D} = 180mA

Figure 8. Typical gate forward current at V_{DS} = 0V



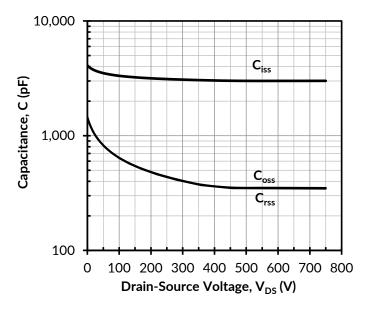








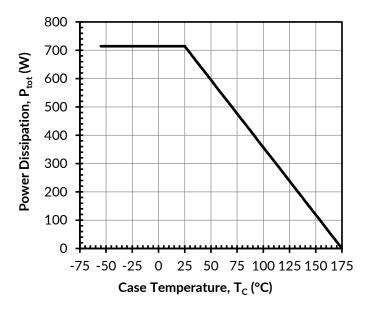




120 100 80 40 20 0 100 200 300 400 500 600 700 800 Drain-Source Voltage, V_{DS} (V)

Figure 9. Typical capacitances at f = 100kHz and $V_{GS} = -20V$

Figure 10. Typical stored energy in C_{OSS} at V_{GS} = -20V



140
120
100
80
40
20
-75 -50 -25 0 25 50 75 100 125 150 175
Case Temperature, T_c (°C)

Figure 11. Total power Dissipation

Figure 12. DC drain current derating



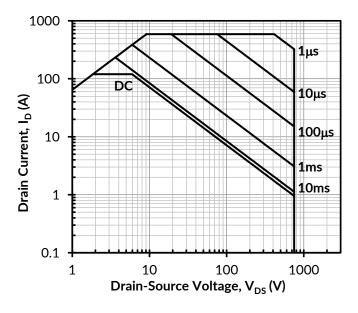












Thermal Impedance, $Z_{\theta JC}$ (°C/W) 1.E-03 1.E-03 = 0.3 = 0.05 D = 0.02D = 0.01Single Pulse Foster model parameters Value (K/W) Symbol Value (Ws/K) 2.900E-03 R2 1.350E-02 1.550E-02 R3 1.650E-01 1.820E-02 1.E-04 1.E-06 1.E-05 1.E-04 1.E-03 1.E-02 1.E-01 Pulse Time, t_p (s)

Figure 13. Safe operation area at T_C =25°C, Parameter t_D

Figure 14. Maximum transient thermal impedance

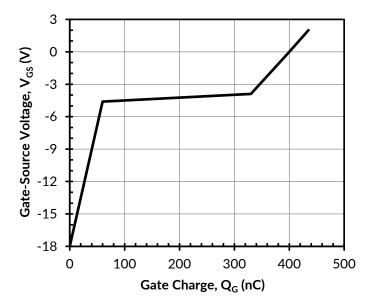


Figure 15. Typical gate charge at V_{DS} = 400V and I_{D} = 80A













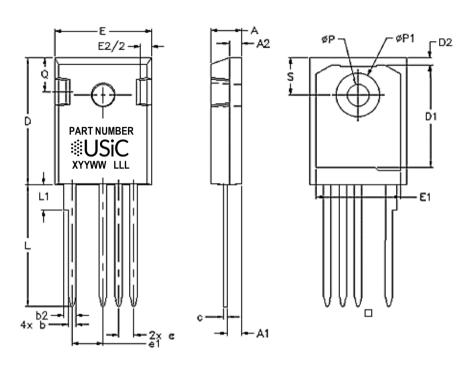
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TO-247-4L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

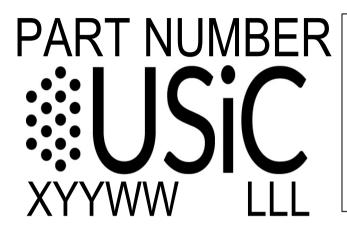
PACKAGE OUTLINE



| DIM | INC | HES | MILLIN | ETERS | |
|-----|-----------|-------|----------|-------|--|
| | MIN | MAX | MIN | MAX | |
| Α | 0.185 | 0.209 | 4.7 | 5.31 | |
| A1 | 0.087 | 0.102 | 2.21 | 2.59 | |
| A2 | 0.059 | 0.098 | 1.5 | 2.49 | |
| b | 0.039 | 0.055 | 0.99 | 1.4 | |
| b2 | 0.065 | 0.094 | 1.65 | 2.39 | |
| С | 0.015 | 0.035 | 0.38 | 0.89 | |
| D | 0.819 | 0.845 | 20.8 | 21.46 | |
| D1 | 0.515 | - | 13.08 | - | |
| D2 | 0.02 | 0.053 | 0.51 | 1.35 | |
| E | 0.61 | 0.64 | 15.49 | 16.26 | |
| е | 0.100 BSC | | 2.54 BSC | | |
| e1 | 0.19 | 0.21 | 4.83 | 5.33 | |
| E1 | 0.53 | - | 13.46 | - | |
| E2 | 0.14 | 0.16 | 3.56 | 4.06 | |
| L | 0.78 | 0.8 | 19.81 | 20.32 | |
| L1 | - | 0.177 | | 4.5 | |
| ФР | 0.14 | 0.144 | 3.56 | 3.66 | |
| ФР1 | 0.278 | 0.291 | 7.06 | 7.39 | |
| Q | 0.212 | 0.244 | 5.38 6.2 | | |
| S | 0.243 BSC | | 6.17 BSC | | |



TO-247-4L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS



PART NUMBER = REFER TO
DS PN DECODER FOR DETAILS

X = ASSEMBLY SITE

YY = YEAR

WW = WORK WFFK

LLL = LOT ID

PACKING TYPE

ANTI-STATIC TUBE

QUANTITY /TUBE: 30 UNITS

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